



P-Channel 12 V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)	Q _g (Typ.)			
	0.156 at V _{GS} = - 4.5 V	1.18				
- 12	0.190 at V _{GS} = - 2.5V	1.07	6.7 nC			
	0.245 at V _{GS} = - 1.8V	0.49				

FEATURES

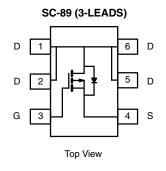
- TrenchFET® Power MOSFET
- 100 % R_g Tested
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

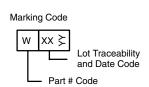


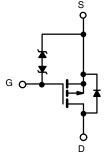
HALOGEN FREE

APPLICATIONS

· Load Switch for Portable Devices







Ordering Information: Si1065X-T1-GE3 (Lead (Pb)-free and Halogen-free)

P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, unless otherwise noted)						
Parameter		Symbol	Limit	Unit		
Drain-Source Voltage	V _{DS}	- 12	V			
Gate-Source Voltage		V_{GS}	± 8	V		
Continuous Drain Current (T _{.I} = 150 °C)	T _A = 25 °C	ı	- 1.18 ^{b, c}			
Continuous Diam Current (1j = 130 C)	T _A = 70 °C	l I _D	- 0.94 ^{b, c}	Α		
Pulsed Drain Current		I _{DM}	- 8	A		
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	- 0.2 ^{b, c}			
Mariana Banas Birainatian	T _A = 25 °C	D.	0.236 ^{b, c}	W		
Maximum Power Dissipation ^a	T _A = 70 °C	P _D	0.151 ^{b, c}			
Operating Junction and Storage Temperature Rai	T _J , T _{stg}	- 55 to 150	°C			

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
	t ≤ 5 s		440	530		
Maximum Junction-to-Ambient ^{a, b}	Steady State State	R_{thJA}	540	650	°C/W	

- a. Maximum under steady state conditions is 650 °C/W.
- b. Surface mounted on 1" x 1" FR4 board.
- c. t = 5 s.

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SPECIFICATIONS (T _J = 25 ° Parameter	Symbol	Test Conditions	Typ.	Max.	Unit		
Static			Min.	7			
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = - 250 μA	- 12			V	
V _{DS} Temperature Coefficient	ΔV _{DS} /T _J	J 050 vA		- 8.47		14/00	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = - 250 μA		2.33		mV/°C	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 0.45		- 0.95	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$			± 100	nA	
Zana Oata Wallana Busin Oamant	1	V _{DS} = - 12 V, V _{GS} = 0 V			- 1	nA	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = -12 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 85 ^{\circ}\text{C}$			- 10	μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} = \ge 5 \text{ V}, V_{GS} = -4.5 \text{ V}$	- 8			Α	
		V _{GS} = - 4.5 V, I _D = - 1.18 A		0.108	0.156		
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 2.5 V, I _D = - 1.07 A		0.131	0.190	Ω	
		$V_{GS} = -1.8 \text{ V}, I_D = -0.49 \text{ A}$		0.158	0.245		
Forward Transconductance	9 _{fs}	$V_{DS} = -6 \text{ V}, I_{D} = -1.18 \text{ A}$		5.18		S	
Dynamic ^b							
Input Capacitance	C _{iss}			480			
Output Capacitance	C _{oss}	$V_{DS} = -6 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		190		pF	
Reverse Transfer Capacitance	C _{rss}			145			
Total Gate Charge	Q_{g}	$V_{DS} = -6 \text{ V}, V_{GS} = -5 \text{ V}, I_D = -1.18 \text{ A}$		7.2	10.8		
				6.7	10.1	nC	
Gate-Source Charge	Q _{gs}	$V_{DS} = -6 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -1.18$		0.84			
Gate-Drain Charge	Q _{gd}			2.7			
Gate Resistance	R _g	f = 1 MHz		10	15	Ω	
Turn-On Delay Time	t _{d(on)}			13	19.5		
Rise Time	t _r	$V_{DD} = -6 \text{ V}, R_L = 6.32 \Omega$		27	40.5	ns	
Turn-Off DelayTime t _{d(off}		$I_D \cong -0.95 \text{ A}, V_{GEN} = -4.5 \text{ V}, R_g = 1 \Omega$		45	67.5		
Fall Time	t _f			27	40.5		
Drain-Source Body Diode Characteris	l			l			
Pulse Diode Forward Current ^a	I _{SM}	1 000 4		0.5	8	Α	
Body Diode Voltage	V _{SD}	I _S = - 0.63 A		0.8	1.2	V	
Body Diode Reverse Recovery Time t _{rr}				29.2	44	nC	
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = - 0.7 A, dI/dt = 100 A/μs		10.22	15.3	ns	
Reverse Recovery Fall Time	t _a			13.7			
Reverse Recovery Rise Time	t _b			15.5			

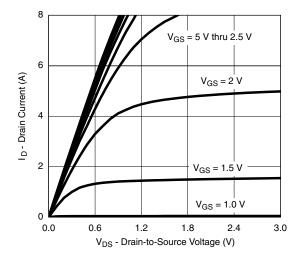
Notes:

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

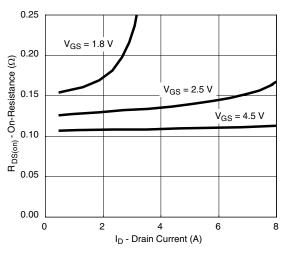
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



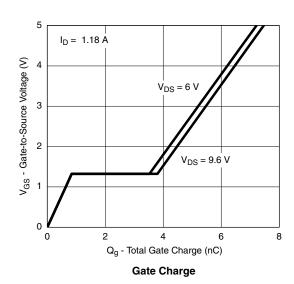
TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)

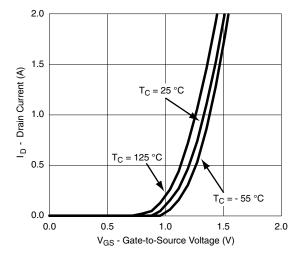


Output Characteristics

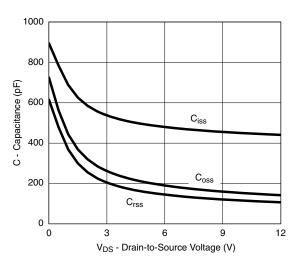


On-Resistance vs. Drain Current

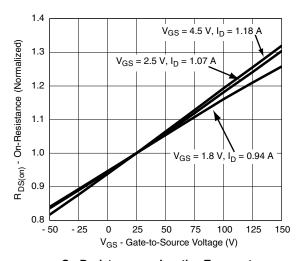




Transfer Characteristics Curves vs. Temp.



Capacitance

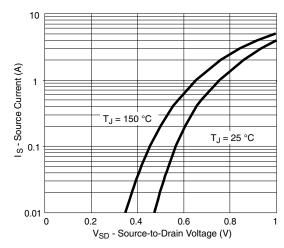


On-Resistance vs. Junction Temperature

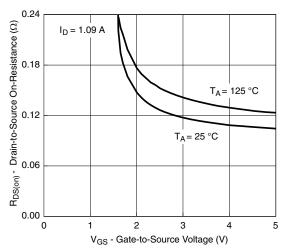
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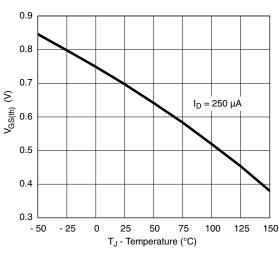
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



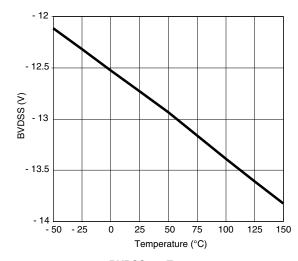
Source-Drain Diode Forward Voltage



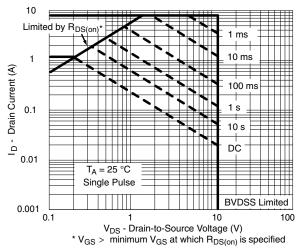
 $R_{DS(on)}$ vs. V_{GS} vs. Temperature



Threshold Voltage



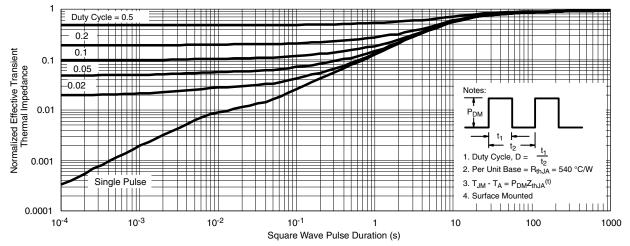
BVDSS vs. Temparture



Safe Operating Area, Junction-to-Ambient



TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)

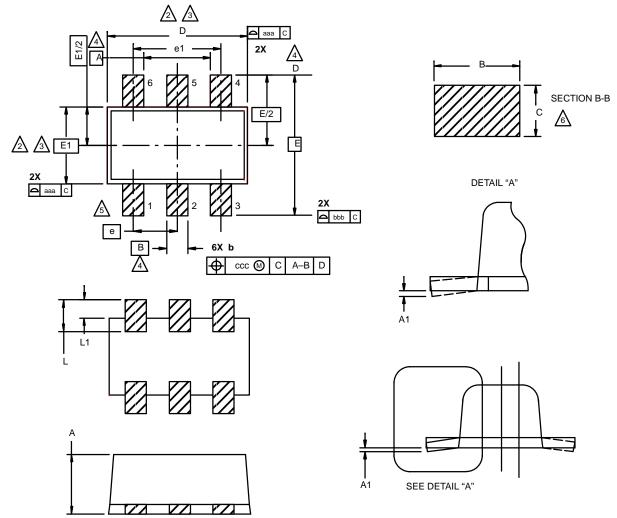


Normalized Thermal Transient Impedance, Junction-to-Ambient

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?74320.



SC89: 6- LEADS (SOT-563F)



NOTES:

1. Dimensions in millimeters.



Dimension D does not include mold flash, protrusions or gate burrs. Mold flush, protrusions or gate burrs shall not exceed 0.15 mm per dimension E1 does not include interlead flash or protrusion, interlead flash or protrusion shall not exceed 0.15 mm per side.



Dimensions D and E1 are determined at the outmost extremes of the plastic body exclusive of mold flash, the bar burrs, gate burrs and interlead flash, but including any mismatch between the top and the bottom of the plastic body.



Datums A, B and D to be determined 0.10 mm from the lead tip.



Terminal numbers are shown for reference only.



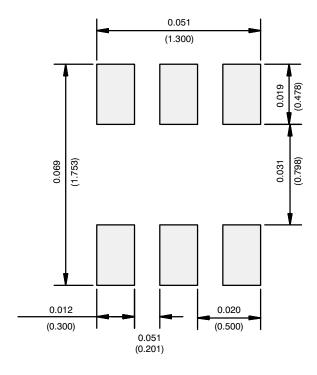
These dimensions apply to the flat section of the lead between 0.08 mm and 0.15 mm from the lead tip.

	MILLIMETERS				Tolerances Of Form And			
Dim	Min	Max	Note	Symbol	Position			
Α	0.56	0.60		aaa	0.10			
A1	0.00	0.10		bbb	0.10			
b	0.15	0.30		ccc	0.10			
С	0.10	0.18						
D	1.50	1.70	2, 3					
E	1.55	1.70						
E1	1.20 BSC		2, 3					
е	0.50 BSC							
e1	1.00 BSC							
L	0.35 BSC							
L1	0.20 BSC							

DWG: 5880



RECOMMENDED MINIMUM PADS FOR SC-89: 6-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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